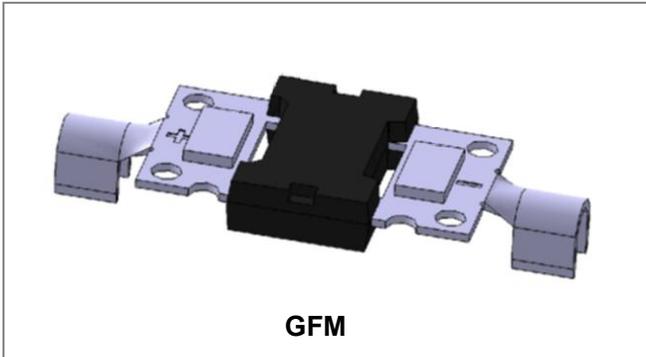


GF4045TS Power Modules Schottky Rectifier



Features

- Low thermal resistance
- Lower forward voltage drop, low power loss
- Isolate Package design, ideal for heat dispersion
- High forward current capability
- Trench MOS Schottky technology
- Excellent anti-humidity
- Low profile package
- High forward surge capability
- All SMC parts are traceable to the wafer lot
- Additional electrical and life testing can be performed upon request

Mechanical Data

- **Case:** GFM
- High temperature soldering guaranteed
- Heated-tool welding 260°C, 10 seconds
- **Marking Code:** GF4045TS

Maximum Ratings (limiting values, at 25 °C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	-	45	V
Average Rectified Forward Current	$I_F (AV)$	$T_C = 110^\circ C, I_n DC$	40	A
Peak One Cycle Non-Repetitive Surge Current	I_{FSM}	8.3 ms, half Sine pulse	350	A

Electrical Characteristics

Characteristics	Symbol	Condition	Typ.	Max.	Units
Forward Voltage Drop*	V_{F1}	@ 40A, Pulse, $T_J = 25^\circ C$	0.48	0.52	V
Reverse Current*	I_{R1}	@ $V_R = \text{rated } V_R, T_J = 25^\circ C$	0.03	0.20	mA
	I_{R2}	@ $V_R = \text{rated } V_R, T_J = 100^\circ C$	-	12	mA
	I_{R3}	@ $V_R = \text{rated } V_R, T_J = 125^\circ C$	26	55	mA
Junction Capacitance	C_T	@ $V_R = 5V, T_C = 25^\circ C$ $f_{SIG} = 1MHz$	5840	-	pF

* Pulse width < 300 μs , duty cycle < 2%

Thermal-Mechanical Specifications(Ta=25°C Unless otherwise specified)

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	T _J	IN DC Forward Mode, without reverse bias, t ≤ 1 h	-55 to +200	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	R _{θJC}	-	1.5	°C/W

Ratings and Characteristics Curves

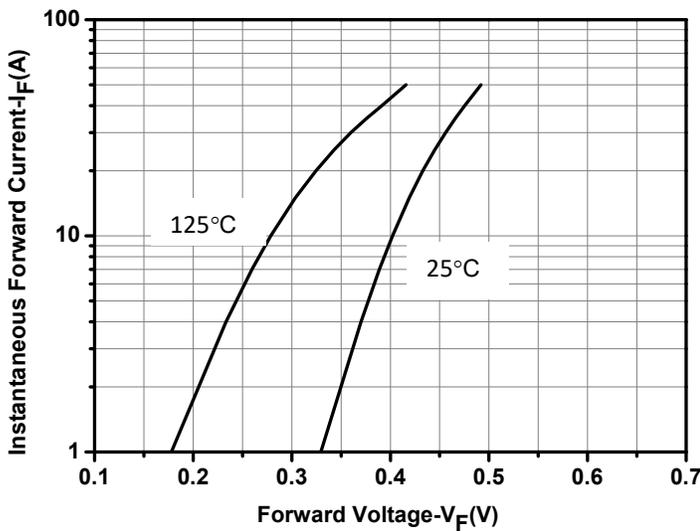


Fig.1-Typical Forward Voltage Characteristics

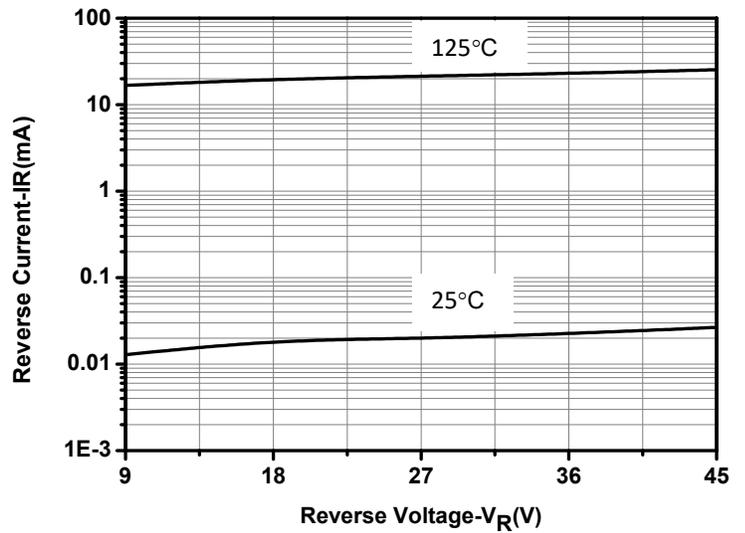


Fig.2-Typical Reverse Characteristics

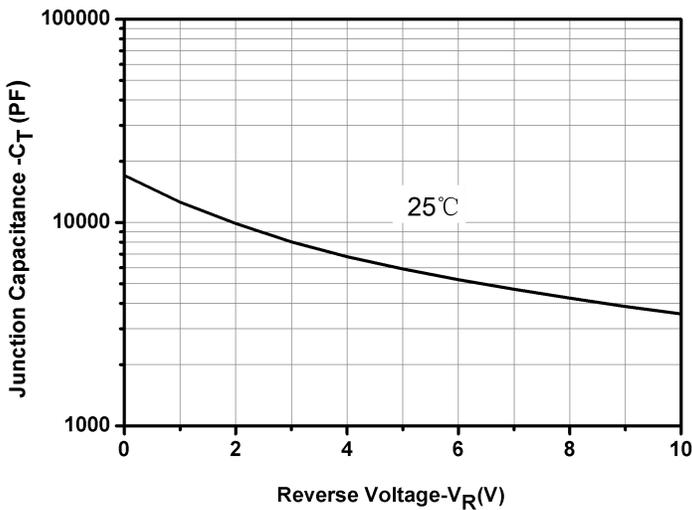
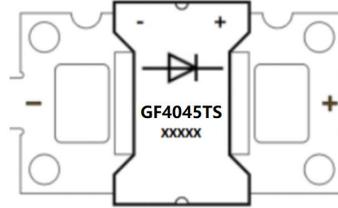


Fig.3-Capacitance vs. Reverse Voltage

Ordering Information

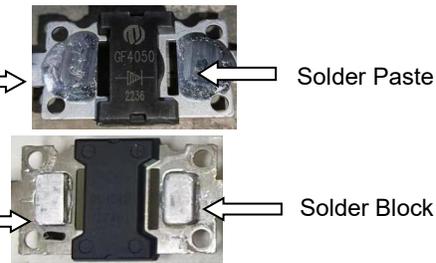
Device	Package	Shipping
GF4045TS	GFM	30pcs / Tube

Marking Diagram

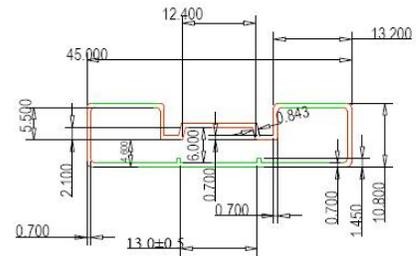
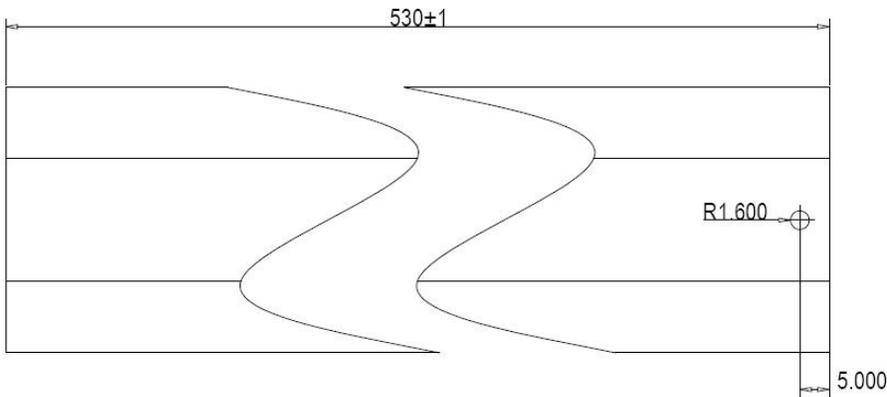


Where XXXXX is YYWWL
 GF4045TS = Marking Code
 YY = Year
 WW = Week
 L = Lot Number

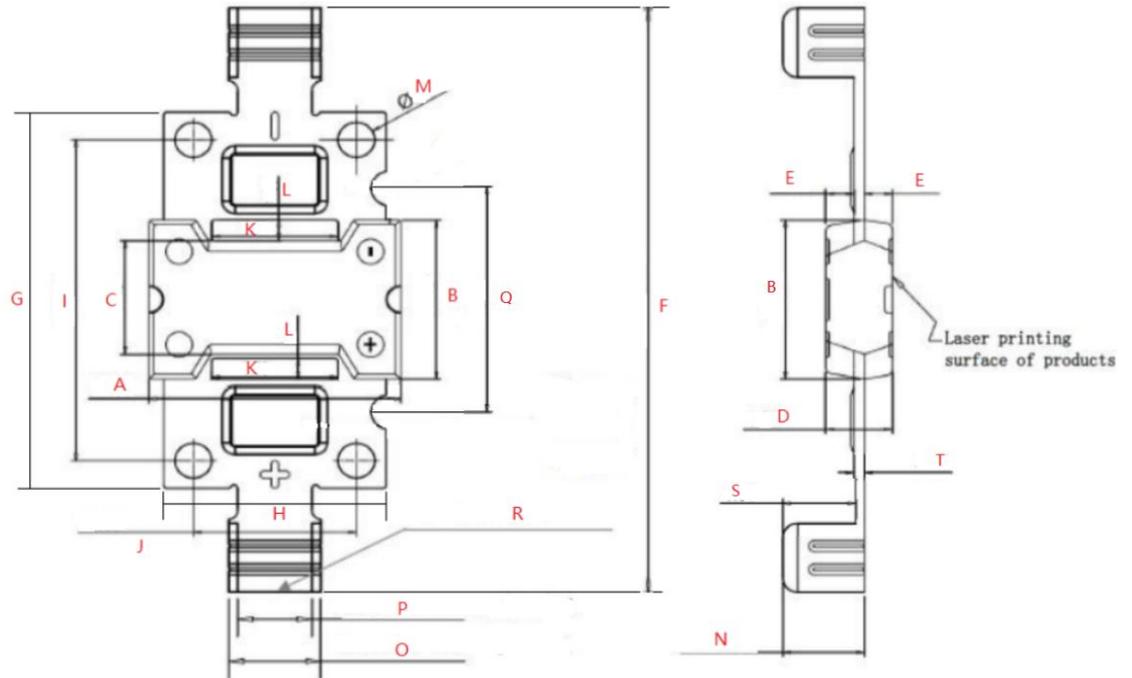
Order P/N	Terminals	Additional
GF4045TS-S1	Tin Plated	None
GF4045TS-S2	Tin Plated	Solder Paste
GF4045TS-S3	Tin Plated	Solder Block
GF4045TS-N1	Nickel Plated	None
GF4045TS-N2	Nickel Plated	Solder Paste
GF4045TS-N3	Nickel Plated	Solder Block



Tube Specification GFM (Millimeters)



Mechanical Dimensions GFM (Millimeters)



Symbol	Dimensions in millimeters		
	Min.	Typical	Max
A	16.90	17.00	17.10
B	11.38	11.48	11.58
C	8.15	8.20	8.25
D	4.40	4.50	4.60
E	1.85	1.90	1.95
F	41.90	42.00	42.10
G	26.90	27.00	27.10
H	14.90	15.00	15.60
I	22.90	23.00	23.10
J	10.90	11.00	11.10
K	-	8.50	-
L	-	1.50	-
M	-	∅ 2.50	2.55
N	5.35	5.50	5.65
O	6.20	6.30	6.40
P	4.90	5.00	5.10
Q	15.95	16.00	16.05
R	2.80	2.90	3.00
S	4.75	4.80	4.85
T	0.67	0.70	0.73

Dimension H includes Burrs/cutting residuals.

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